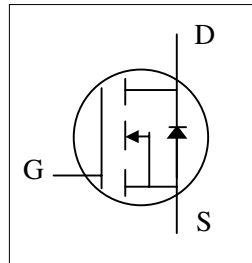




- ▼ 100% Avalanche Test
- ▼ Fast Switching Characteristic
- ▼ Simple Drive Requirement

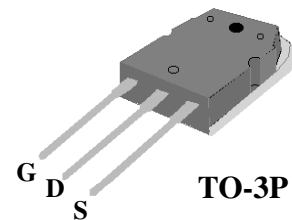


BV_{DSS}	750V
$R_{DS(ON)}$	1.45 Ω
I_D	8.0A

Description

AP2763 series are specially designed as main switching devices for universal 90~265VAC off-line AC/DC converter applications.

The TO-3P package is widely preferred for commercial-industrial applications. The device is suited for switch mode power supplies, DC-AC converters and high current high speed switching circuits.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	750	V
V_{GS}	Gate-Source Voltage	± 30	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, V_{GS} @ 10V	8.0	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, V_{GS} @ 10V	5.0	A
I_{DM}	Pulsed Drain Current ¹	30	A
$P_D@T_C=25^\circ C$	Total Power Dissipation	138	W
	Linear Derating Factor	1.11	W/ $^\circ C$
E_{AS}	Single Pulse Avalanche Energy ²	32	mJ
I_{AR}	Avalanche Current	8.0	A
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Value	Units
Rthj-c	Maximum Thermal Resistance, Junction-case	0.9	$^\circ C/W$
Rthj-a	Maximum Thermal Resistance, Junction-ambient	40	$^\circ C/W$



AP2763W-A

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =1mA	750	-	-	V
ΔBV _{DSS} /ΔT _j	Breakdown Voltage Temperature Coefficient	Reference to 25°C, I _D =1mA	-	0.9	-	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ³	V _{GS} =10V, I _D =4.0A	-	-	1.45	Ω
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	2	-	4	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =4.0A	-	3.6	-	S
I _{DSS}	Drain-Source Leakage Current	V _{DS} =700V, V _{GS} =0V	-	-	10	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±30V	-	-	±100	nA
Q _g	Total Gate Charge ³	I _D =4A	-	47	75	nC
Q _{gs}	Gate-Source Charge	V _{DS} =600V	-	8.5	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =10V	-	20	-	nC
t _{d(on)}	Turn-on Delay Time ³	V _{DD} =360V	-	15	-	ns
t _r	Rise Time	I _D =4A	-	13	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =10Ω, V _{GS} =10V	-	74	-	ns
t _f	Fall Time	R _D =90Ω	-	21	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	1880	3010	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	140	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	9	-	pF
R _g	Gate Resistance	f=1.0MHz	-	2.6	3.9	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ³	I _S =4.0A, V _{GS} =0V	-	-	1.5	V
t _{rr}	Reverse Recovery Time ³	I _S =4.0A, V _{GS} =0V,	-	400	-	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	7	-	μC

Notes:

- 1.Pulse width limited by max. junction temperature.
- 2.Starting T_j=25°C , V_{DD}=50V , R_G=25Ω , I_{AS}=8.0A.
- 3.Pulse test

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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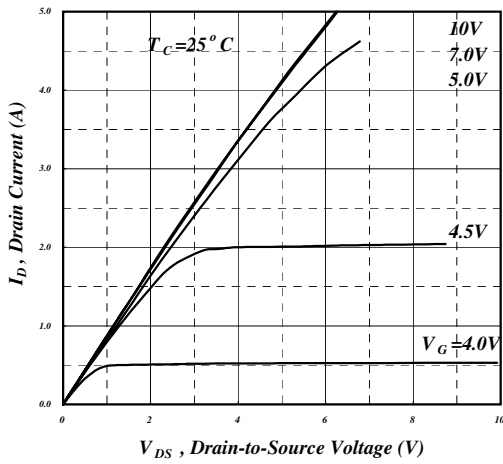


Fig 1. Typical Output Characteristics

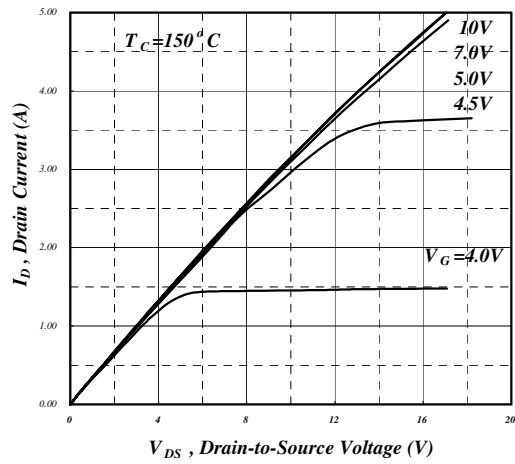


Fig 2. Typical Output Characteristics

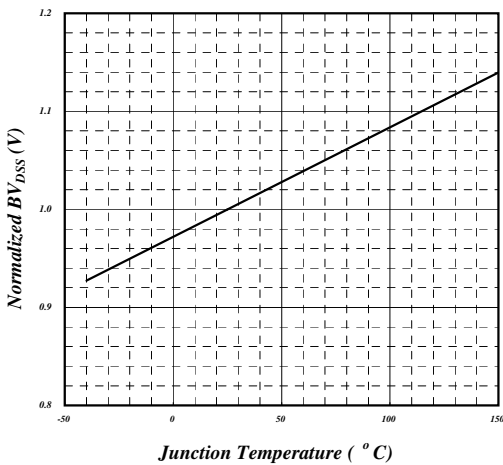


Fig 3. Normalized BV_{DS} v.s. Junction Temperature

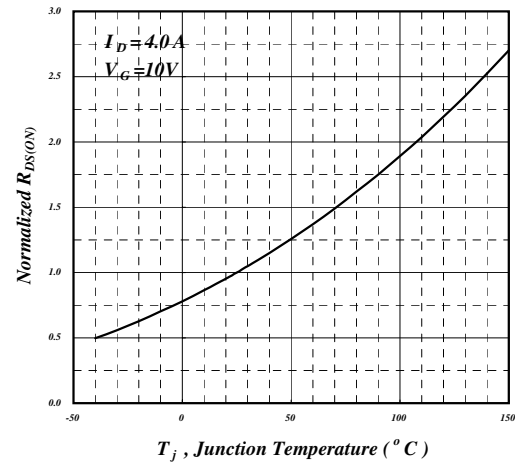


Fig 4. Normalized On-Resistance v.s. Junction Temperature

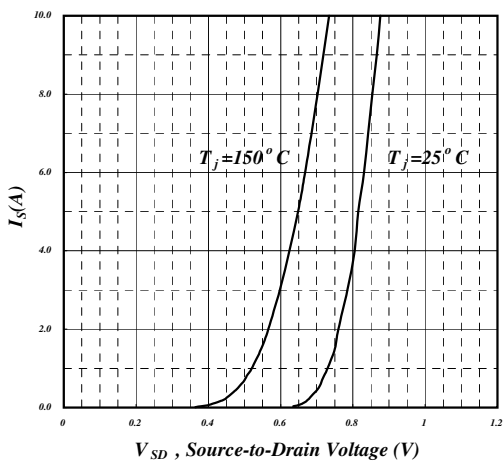


Fig 5. Forward Characteristic of Reverse Diode

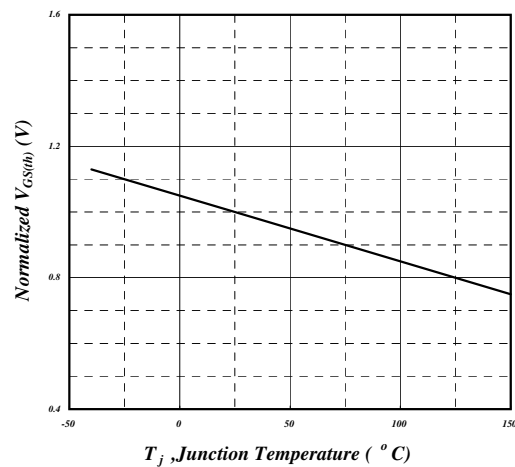


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

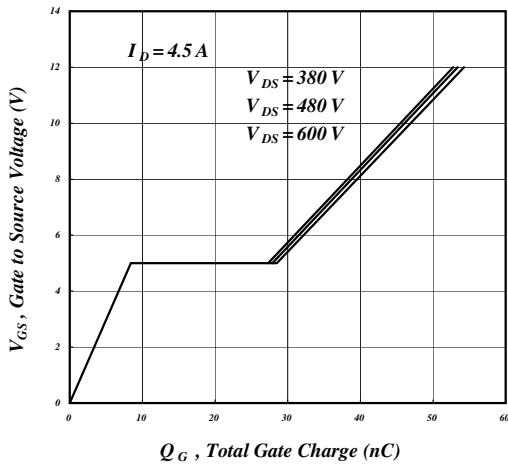


Fig 7. Gate Charge Characteristics

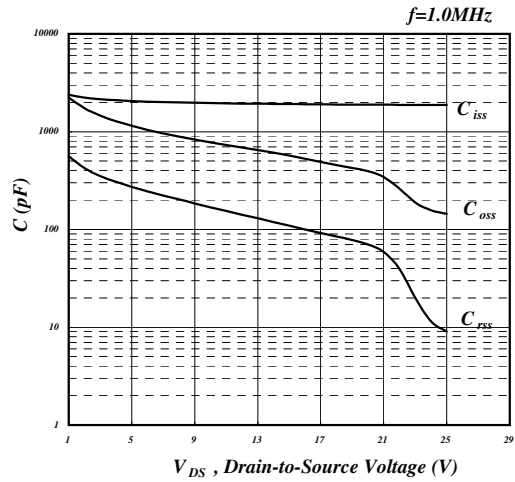


Fig 8. Typical Capacitance Characteristics

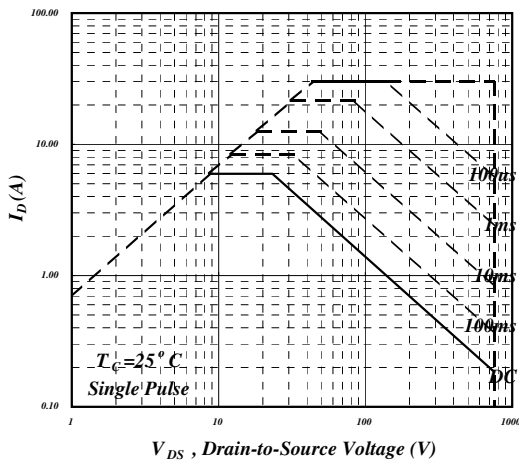


Fig 9. Maximum Safe Operating Area

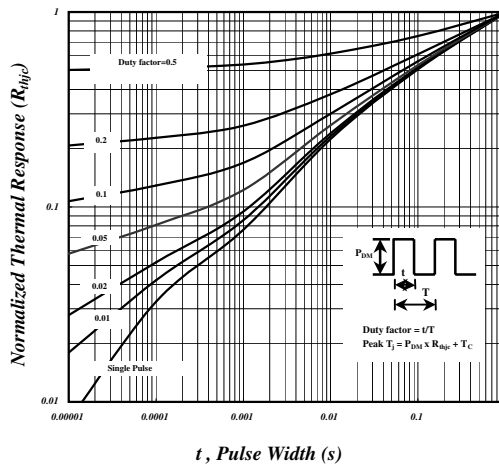


Fig 10. Effective Transient Thermal Impedance

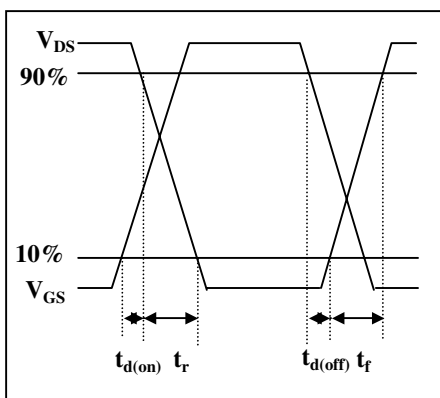


Fig 11. Switching Time Waveform

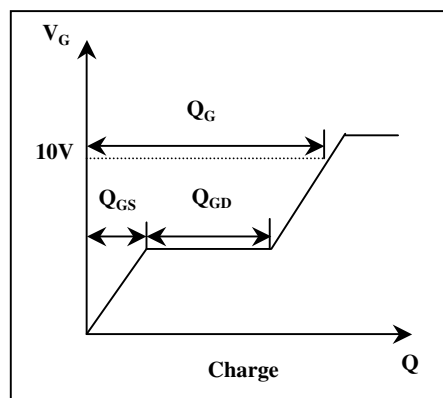
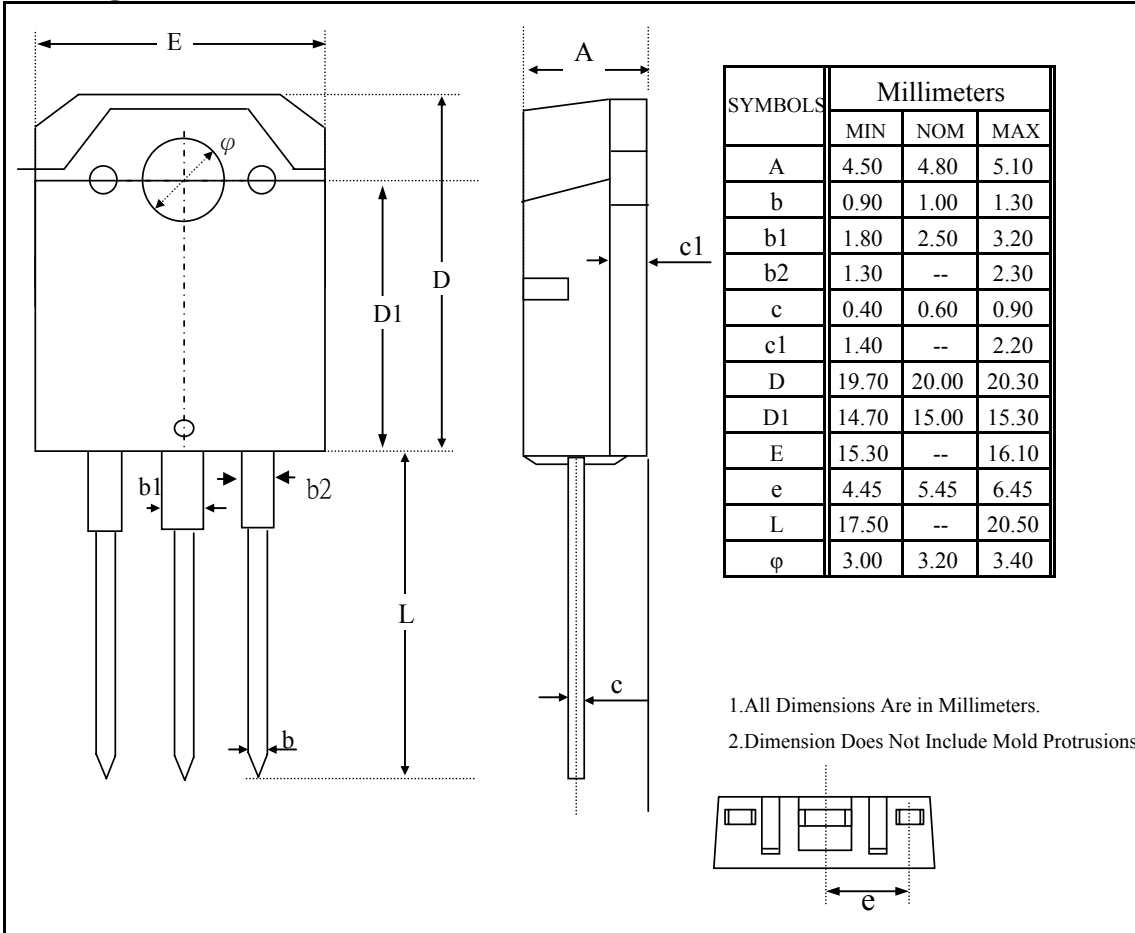


Fig 12. Gate Charge Waveform



Package Outline : TO-3P



Part Marking Information & Packing : TO-3P

